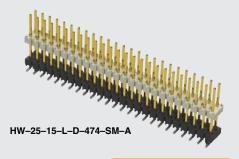




HW-15-08-G-S-335-SM



OPTION



HW-SM SERIES

(2.54 mm) .100"

BLE .025" SQ BOARD STACKERS

STYLE

Board Mates:

SSW, SSQ, ESW, ESQ, CES, SLW, BSW, BCS, SSM, HLE, PHF

Cable Mates:

IDSS, IDSD, SMSD, SMSS

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?HW-SM

Insulator Material:

Top: Natural LCP Bottom: Black LCP Terminal Material: Phosphor Bronze Plating:
Au or Sn over
50 μ" (1.27 μm) Ni
Operating Temp Range:
-55 °C to +125 °C with Gold
-55 °C to +105 °C with Tin RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity:

(0.15 mm) .006" max

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





ALSO AVAILABLE (MOQ Required)

- · Other platings
- · Locking Clip (Manual placement required) available with double row -SM

Contact Samtec.

Note: For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

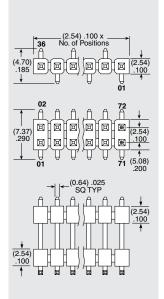
Note: This Series is non-standard, non-returnable,



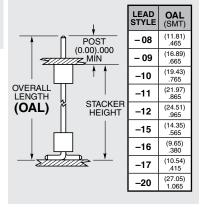
02 thru 36

NO. PINS

PER ROW



Specify LEAD STYLE from chart



ROW OPTION

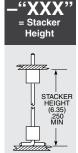






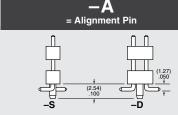






= Polarized

Specify omitted pin position



(Metal or plastic at Samtec discretion)

–TR = Tape & Reel Packaging

(4–27 pins per row only) (Not Available on Lead Styles 10, 11, 12 & 20)

= Gold flash on contact, Matte Tin on tail

= 10 $\mu^{\text{\tiny{II}}}$ (0.25 $\mu m)$ Gold on contact area of longer tail, Matte Tin on tail

 $-\mathsf{G}$ = 10 μ" (0.25 μm) Gold on contact area of longer tail, Gold flash on balance

= Matte Tin

■ WWW.SAMTEC.COM ■